



# BC857xQB series

45 V, 100 mA PNP general-purpose transistor

Rev. 4 — 20 September 2021

Product data sheet

## 1. General description

PNP general-purpose transistor in an ultra small DFN1110D-3 (SOT8015) leadless Surface-Mounted Device (SMD) plastic package with side-wettable flanks.

Table 1. Product overview

Type number	Package		NPN complement:
	Nexperia	JEDEC	
BC857AQB	SOT8015	MO-340BA	BC847AQB
BC857BQB			BC847BQB
BC857CQB			BC847CQB

## 2. Features and benefits

- High power dissipation capability
- Suitable for Automatic Optical Inspection (AOI) of solder joint
- Smaller footprint compared to conventional leaded SMD packages
- Low package height of 0.5 mm
- AEC-Q101 qualified

## 3. Applications

- General-purpose switching and amplification
- Space restricted applications

## 4. Quick reference data

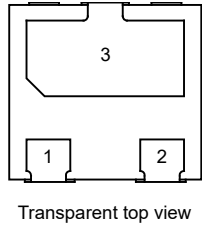
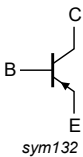
Table 2. Quick reference data

$T_{amb} = 25\text{ °C}$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{CEO}$	collector-emitter voltage	open base	-	-	-45	V
$I_C$	collector current		-	-	-100	mA
$I_{CM}$	peak collector current	single pulse; $t_p \leq 1\text{ ms}$	-	-	-200	mA
$h_{FE}$	DC current gain					
	BC857AQB	$V_{CE} = -5\text{ V}; I_C = -2\text{ mA}$	125	-	250	
	BC857BQB		220	-	475	
	BC857CQB		420	-	800	

## 5. Pinning information

Table 3. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	B	base	 <p>Transparent top view</p>	 <p>sym132</p>
2	E	emitter		
3	C	collector		

## 6. Ordering information

Table 4. Ordering information

Type number	Package		
	Name	Description	Version
BC857AQB	DFN1110D-3	plastic leadless extremely thin small outline package with side-wettable flanks (SWF); 3 terminals; 0.65 mm pitch; body: 1.1 mm x 1.0 mm x 0.48 mm	SOT8015
BC857BQB			
BC857CQB			

## 7. Marking

Table 5. Marking

Type number	Marking code
BC857AQB	A5
BC857BQB	A6
BC857CQB	A7

## 8. Limiting values

**Table 6. Limiting values**

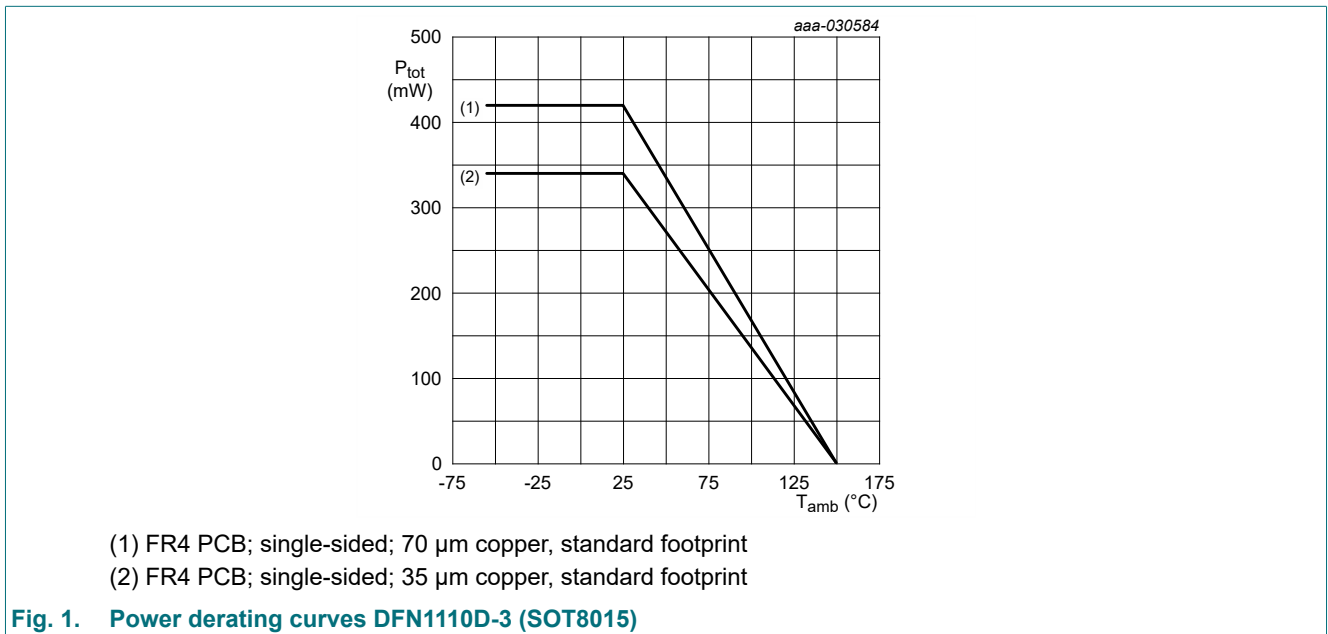
In accordance with the Absolute Maximum Rating System (IEC 60134).

$T_{amb} = 25\text{ °C}$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Max	Unit	
$V_{CBO}$	collector-base voltage	open emitter	-	-50	V	
$V_{CEO}$	collector-emitter voltage	open base	-	-45	V	
$V_{EBO}$	emitter-base voltage	open collector	-	-6	V	
$I_C$	collector current		-	-100	mA	
$I_{CM}$	peak collector current	single pulse; $t_p \leq 1\text{ ms}$	-	-200	mA	
$I_{BM}$	peak base current	single pulse; $t_p \leq 1\text{ ms}$	-	-100	mA	
$P_{tot}$	total power dissipation	$T_{amb} \leq 25\text{ °C}$	[1]	-	340	mW
			[2]	-	420	mW
$T_j$	junction temperature		-	150	°C	
$T_{amb}$	ambient temperature		-55	150	°C	
$T_{stg}$	storage temperature		-65	150	°C	

[1] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided; 35  $\mu\text{m}$  copper; tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB; single-sided; 70  $\mu\text{m}$  copper; tin-plated and standard footprint.



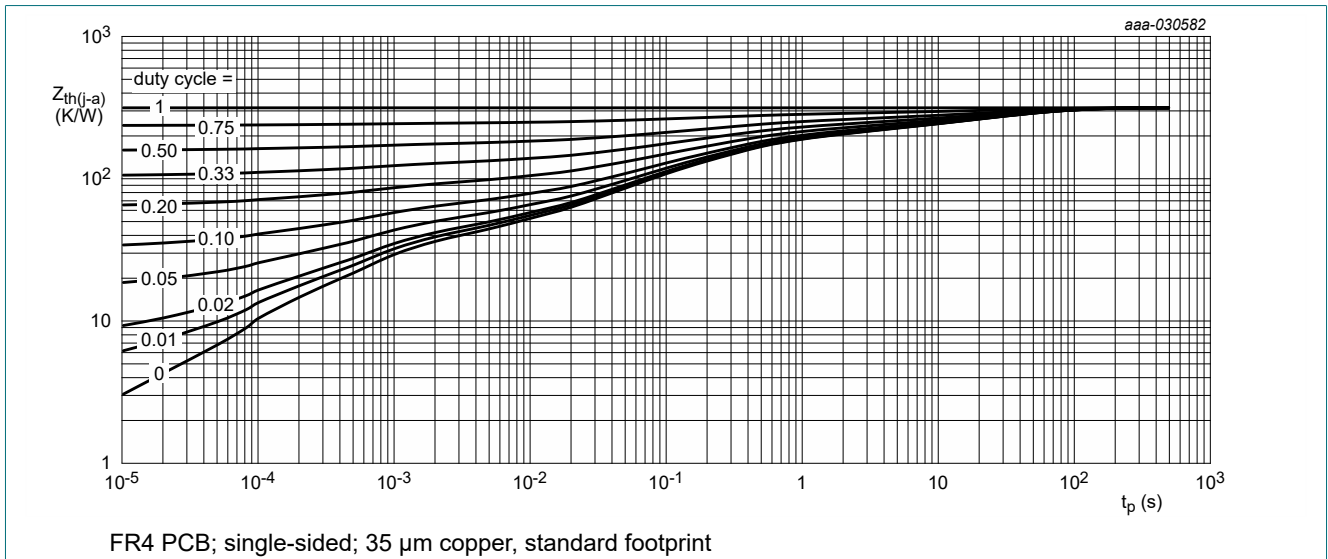
## 9. Thermal characteristics

**Table 7. Thermal characteristics**

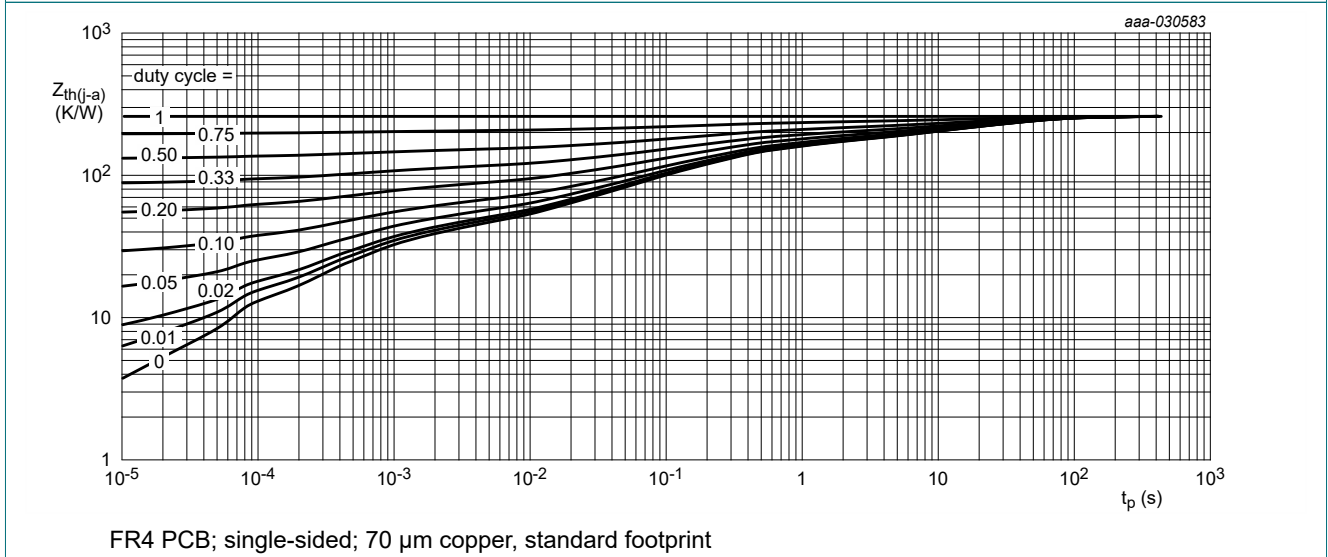
$T_{amb} = 25\text{ °C}$  unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	368	K/W
			[2]	-	-	298	K/W

- [1] Device mounted on an FR4 PCB; single-sided; 35  $\mu\text{m}$  copper; tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB; single-sided; 70  $\mu\text{m}$  copper; tin-plated and standard footprint.



**Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values**



**Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values**

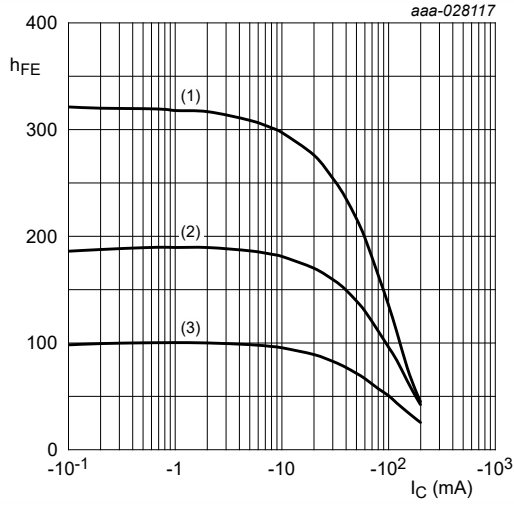
## 10. Characteristics

**Table 8. Characteristics**
 $T_{amb} = 25\text{ °C}$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{(BR)CBO}$	collector-base breakdown voltage	$I_C = -100\ \mu\text{A}$ ; $I_E = 0\ \text{A}$	-50	-	-	V
$V_{(BR)CES}$	collector-emitter peak voltage	$I_C = -2\ \text{mA}$ ; $I_E = 0\ \text{A}$	-45	-	-	V
$V_{(BR)EBO}$	emitter-base breakdown voltage	$I_E = -100\ \mu\text{A}$ ; $I_C = 0\ \text{A}$	-6	-	-	V
$I_{CBO}$	collector-base cut-off current	$V_{CB} = -30\ \text{V}$ ; $I_E = 0\ \text{A}$	-	-	-15	nA
		$V_{CB} = -30\ \text{V}$ ; $I_E = 0\ \text{A}$ ; $T_j = 150\text{ °C}$	-	-	-5	$\mu\text{A}$
$I_{EBO}$	emitter-base cut-off current	$V_{EB} = -5\ \text{V}$ ; $I_C = 0\ \text{A}$	-	-	-100	nA
$h_{FE}$	DC current gain					
	BC857AQB	$V_{CE} = -5\ \text{V}$ ; $I_C = -2\ \text{mA}$	125	-	250	
	BC857BQB		220	-	475	
	BC857CQB		420	-	800	
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = -10\ \text{mA}$ ; $I_B = -0.5\ \text{mA}$	-	-	-300	mV
		$I_C = -100\ \text{mA}$ ; $I_B = -5\ \text{mA}$ [1]	-	-	-650	mV
$V_{BE}$	base-emitter voltage	$V_{CE} = -5\ \text{V}$ ; $I_C = -2\ \text{mA}$ [2]	-600	-	-750	mV
		$V_{CE} = -5\ \text{V}$ ; $I_C = -10\ \text{mA}$ [2]	-	-	-820	mV
$V_{BEsat}$	base-emitter saturation voltage	$I_C = -10\ \text{mA}$ ; $I_B = -0.5\ \text{mA}$	-	-700	-	mV
		$I_C = -100\ \text{mA}$ ; $I_B = -5\ \text{mA}$ [1]	-	-850	-	mV
$f_T$	transition frequency	$V_{CE} = -5\ \text{V}$ ; $I_C = -10\ \text{mA}$ ; $f = 100\ \text{MHz}$	100	-	-	MHz
$C_c$	collector capacitance	$V_{CB} = -10\ \text{V}$ ; $I_E = I_C = 0\ \text{A}$ ; $f = 1\ \text{MHz}$	-	2	-	pF
$C_e$	emitter capacitance	$V_{EB} = -0.5\ \text{V}$ ; $I_C = I_E = 0\ \text{A}$ ; $f = 1\ \text{MHz}$	-	10	-	pF
NF	noise figure	$V_{CE} = -5\ \text{V}$ ; $I_C = -200\ \mu\text{A}$ ; $R_S = 2\ \text{k}\Omega$ ; $f = 1\ \text{kHz}$ ; $B = 200\ \text{Hz}$	-	-	10	dB

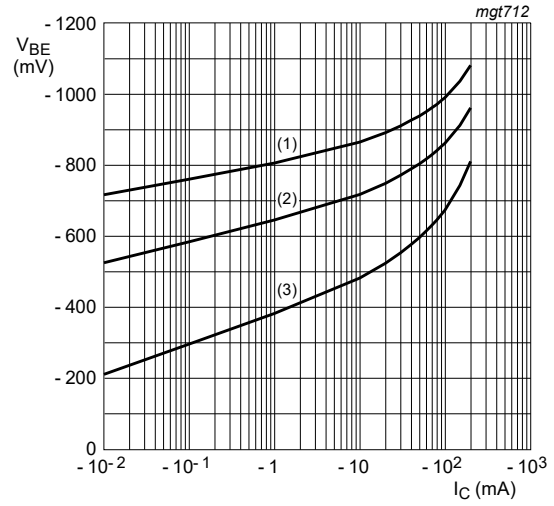
[1] pulsed;  $t_p \leq 300\ \mu\text{s}$ ;  $\delta \leq 0.02$

[2]  $V_{BE}$  decreases by about 2 mV/K with increasing temperature.



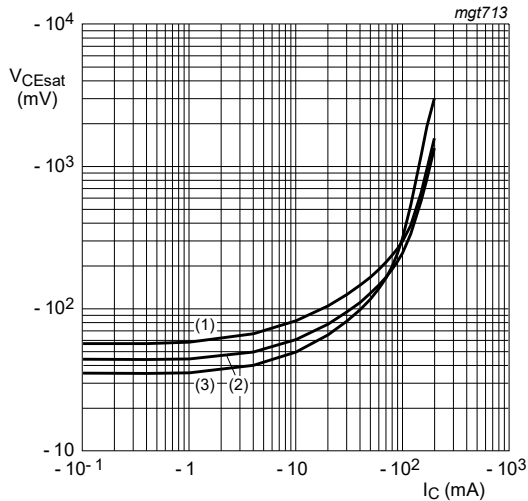
$V_{CE} = -5\text{ V}$   
 (1)  $T_{amb} = 150\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = -55\text{ °C}$

Fig. 4. BC857AQB: DC current gain as a function of collector current; typical values



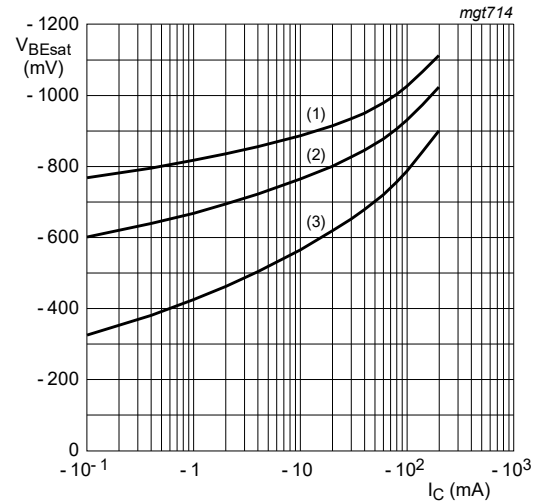
$V_{CE} = -5\text{ V}$   
 (1)  $T_{amb} = -55\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = 150\text{ °C}$

Fig. 5. BC857AQB: Base-emitter voltage as a function of collector current; typical values



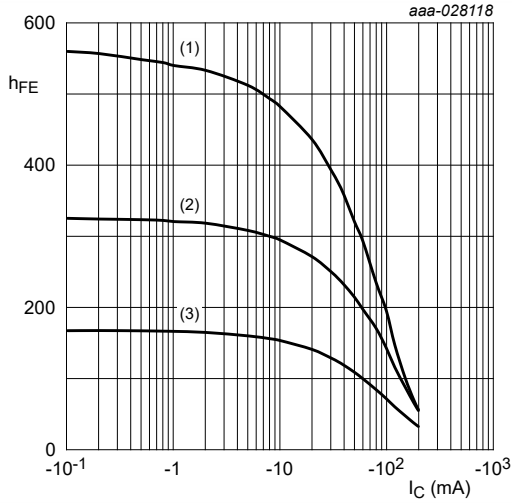
$I_C / I_B = 20$   
 (1)  $T_{amb} = 150\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = -55\text{ °C}$

Fig. 6. BC857AQB: Collector-emitter saturation voltage as a function of collector current; typical values



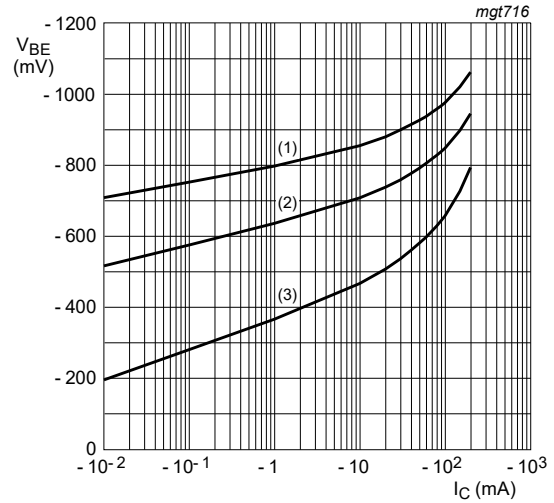
$I_C / I_B = 20$   
 (1)  $T_{amb} = -55\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = 150\text{ °C}$

Fig. 7. BC857AQB: Base-emitter saturation voltage as a function of collector current; typical values



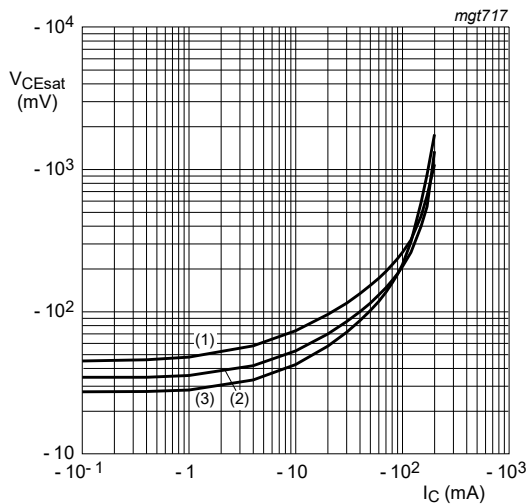
$V_{CE} = -5\text{ V}$   
 (1)  $T_{amb} = 150\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = -55\text{ °C}$

Fig. 8. BC857BQB: DC current gain as a function of collector current; typical values



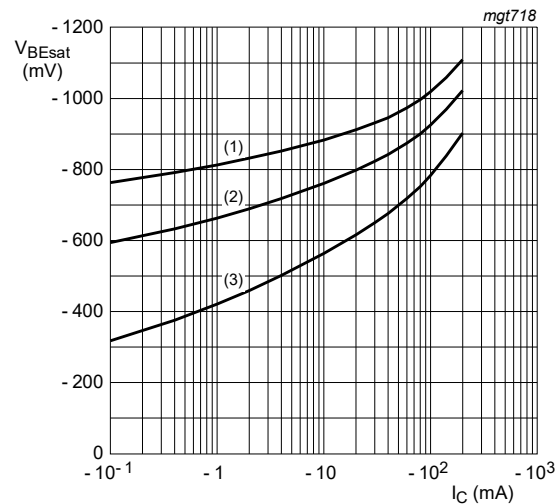
$V_{CE} = -5\text{ V}$   
 (1)  $T_{amb} = -55\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = 150\text{ °C}$

Fig. 9. BC857BQB: Base-emitter voltage as a function of collector current; typical values



$I_C / I_B = 20$   
 (1)  $T_{amb} = 150\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = -55\text{ °C}$

Fig. 10. BC857BQB: Collector-emitter saturation voltage as a function of collector current; typical values



$I_C / I_B = 20$   
 (1)  $T_{amb} = -55\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = 150\text{ °C}$

Fig. 11. BC857BQB: Base-emitter saturation voltage as a function of collector current; typical values

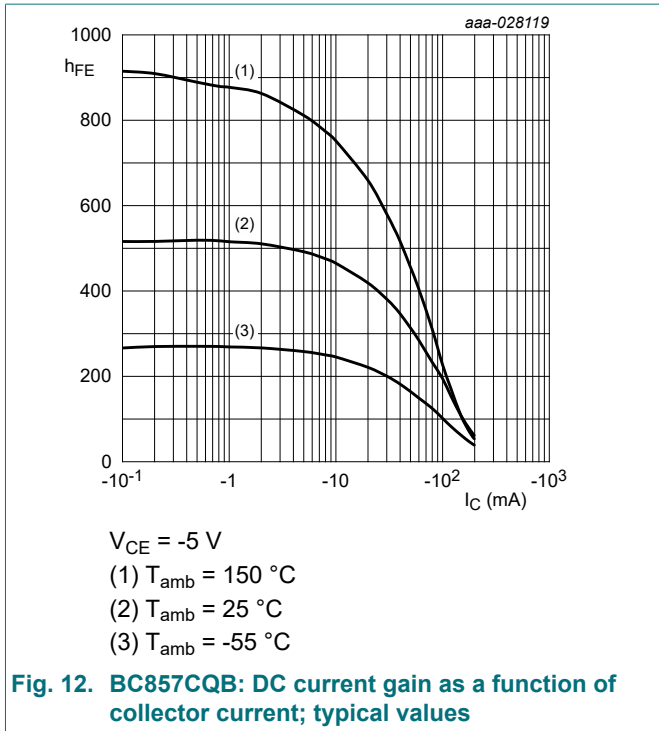


Fig. 12. BC857CQB: DC current gain as a function of collector current; typical values

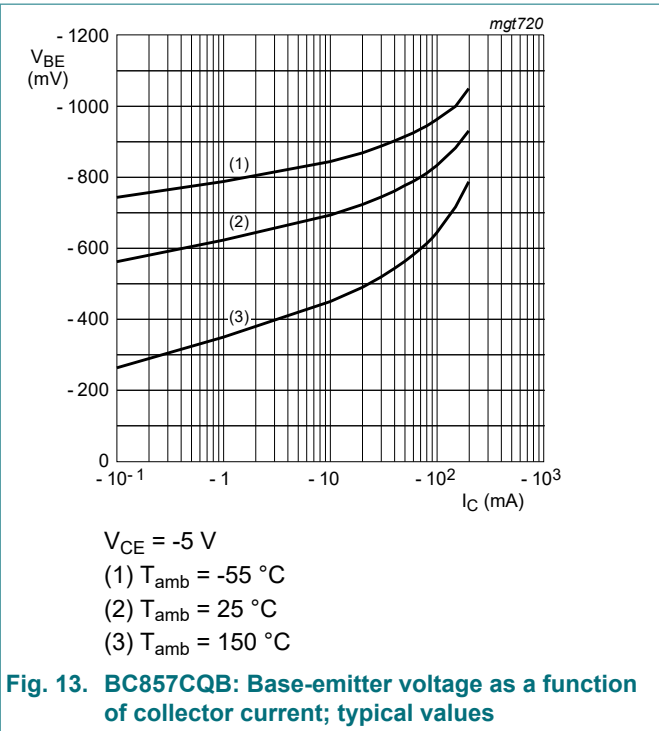


Fig. 13. BC857CQB: Base-emitter voltage as a function of collector current; typical values

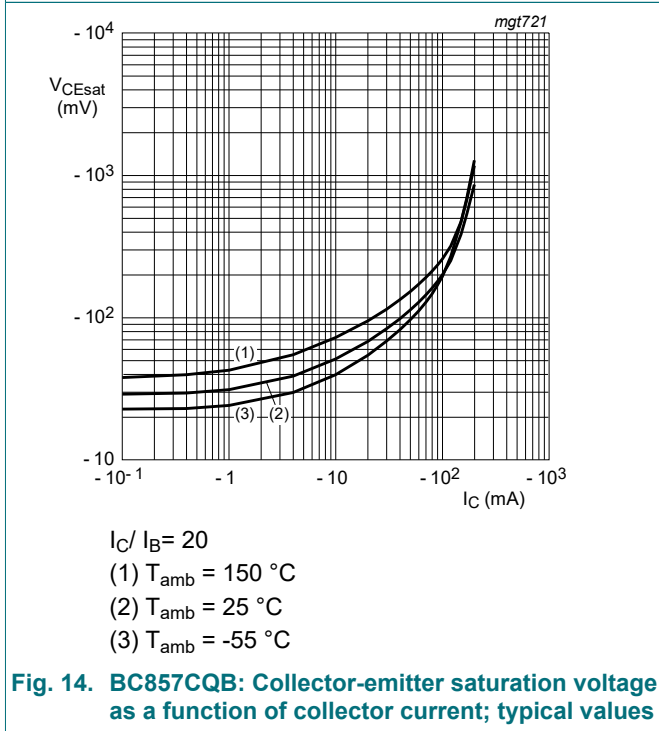


Fig. 14. BC857CQB: Collector-emitter saturation voltage as a function of collector current; typical values

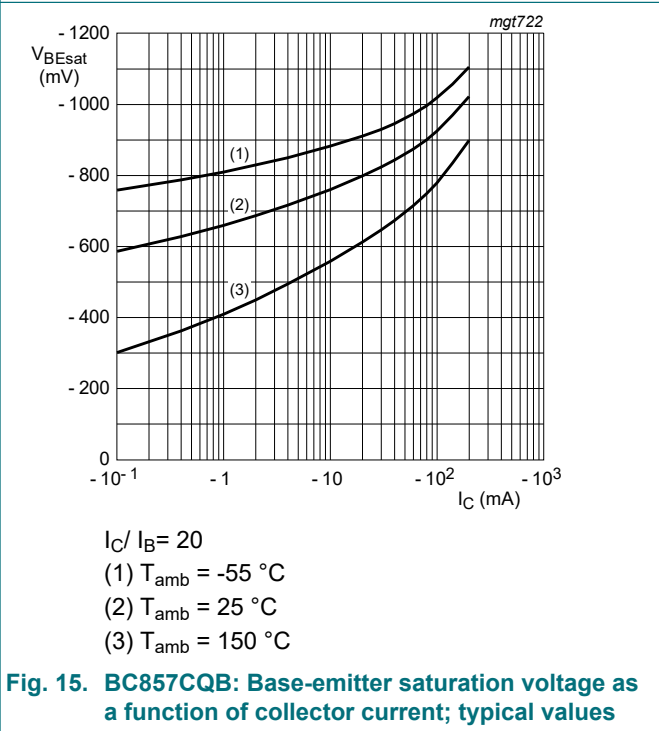


Fig. 15. BC857CQB: Base-emitter saturation voltage as a function of collector current; typical values

## 11. Test information

### Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

## 12. Package outline

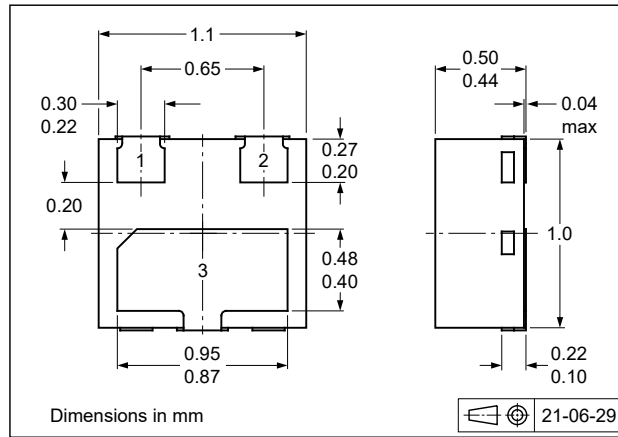
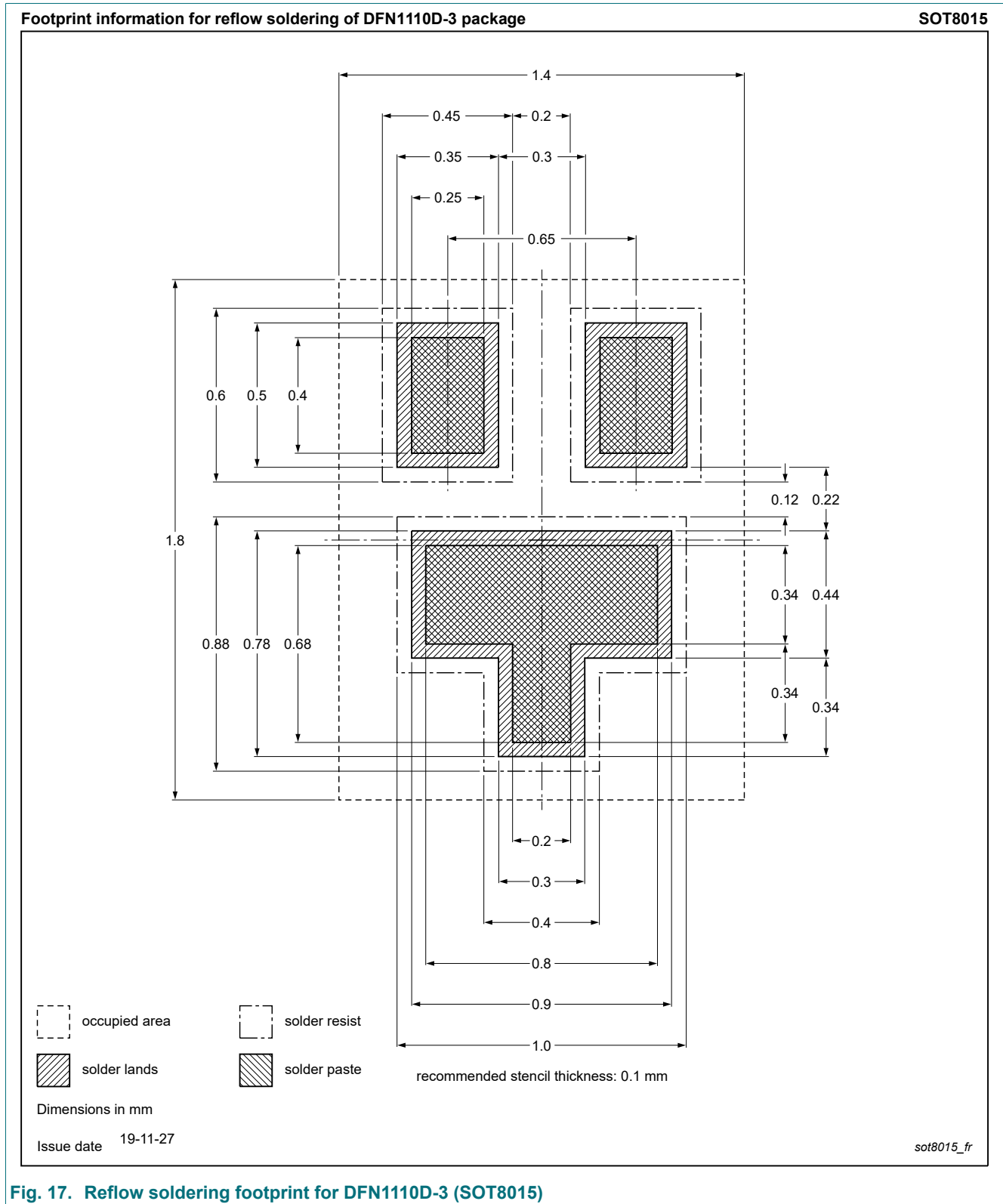


Fig. 16. Package outline DFN1110D-3 (SOT8015)

### 13. Soldering



**Fig. 17. Reflow soldering footprint for DFN1110D-3 (SOT8015)**

## 14. Revision history

**Table 9. Revision history**

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BC857XQB_SER v.4	20210920	Product data sheet	-	BC857XQB_SER v.3
Modifications:	• Characteristics: $C_e$ adjusted			
BC857XQB_SER v.3	20210908	Product data sheet	-	BC857XQB_SER v.2
BC857XQB_SER v.2	20201209			BC857XQB_SER v.1
BC857XQB_SER v.1	20200427	Preliminary data sheet	-	-

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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Date of release: 20 September 2021

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